

MC10H640, MC100H640

68030/040 PECL to TTL Clock Driver

Description

The MC10H/100H640 generates the necessary clocks for the 68030, 68040 and similar microprocessors. It is guaranteed to meet the clock specifications required by the 68030 and 68040 in terms of part-to-part skew, within-part skew and also duty cycle skew.

The user has a choice of using either TTL or PECL (ECL referenced to +5.0 V) for the input clock. TTL clocks are typically used in present MPU systems. However, as clock speeds increase to 50 MHz and beyond, the inherent superiority of ECL (particularly differential ECL) as a means of clock signal distribution becomes increasingly evident. The H640 also uses differential PECL internally to achieve its superior skew characteristic.

The H640 includes divide-by-two and divide-by-four stages, both to achieve the necessary duty cycle skew and to generate MPU clocks as required. A typical 50 MHz processor application would use an input clock running at 100 MHz, thus obtaining output clocks at 50 MHz and 25 MHz (see Logic Diagram).

Features

- Generates Clocks for 68030/040
- Meets 030/040 Skew Requirements
- TTL or PECL Input Clock
- Extra TTL and PECL Power/Ground Pins
- Asynchronous Reset
- Single +5.0 V Supply
- Pb-Free Packages are Available*

Function

Reset (R): LOW on RESET forces all Q outputs LOW and all \bar{Q} outputs HIGH.

Power-Up: The device is designed to have the POS edges of the \bar{Q} and \bar{Q} outputs synchronized at power up.

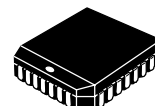
Select (SEL): LOW selects the ECL input source (DE/ \bar{DE}). HIGH selects the TTL input source (DT).

The H640 also contains circuitry to force a stable state of the ECL input differential pair, should both sides be left open. In this case, the DE side of the input is pulled LOW, and \bar{DE} goes HIGH.



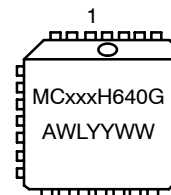
ON Semiconductor®

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PLCC-28
FN SUFFIX
CASE 776

MARKING DIAGRAM*



xxx	= 10 or 100
A	= Assembly Location
WL	= Wafer Lot
YY	= Year
WW	= Work Week
G	= Pb-Free Package

*For additional marking information, refer to Application Note AND8002/D.

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 7 of this data sheet.

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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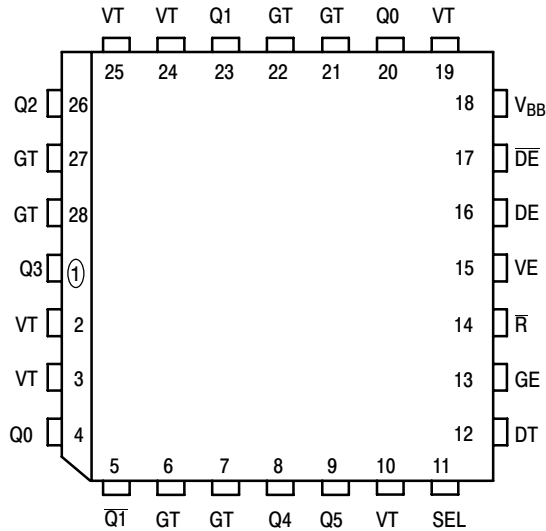


Figure 1. Pinout: PLCC-28
(Top View)

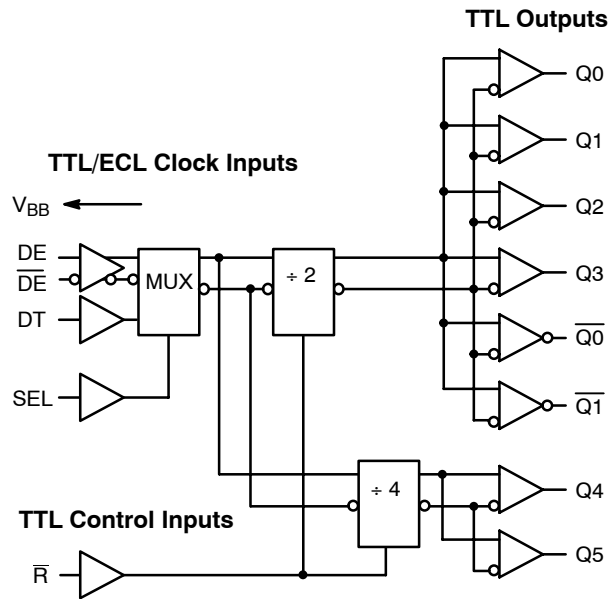


Figure 2. Logic Diagram

Table 1. PIN DESCRIPTION

PIN	FUNCTION
GT	TTL Ground (0 V)
VT	TTL V _{CC} (+5.0 V)
VE	ECL V _{CC} (+5.0 V)
GE	ECL Ground (0 V)
DE, D-barE	ECL Signal Input (positive ECL)
V _{BB}	V _{BB} Reference Output
DT	TTL Signal Input
Qn, Q-bar n	Signal Outputs (TTL)
SEL	Input Select (TTL)
R	Reset (TTL)

Table 2. DC CHARACTERISTICS (V_T = V_E = 5.0 V ±5%)

Symbol	Characteristic	Condition	0°C		25°C		85°C		Unit
			Min	Max	Min	Max	Min	Max	
I _{EE}	Power Supply Current	ECL		57		57		57	mA
I _{CCH}		TTL		30		30		30	
I _{CCL}				30		30		30	

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

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Table 3. 10H PECL DC CHARACTERISTICS ($V_T = V_E = 5.0\text{ V} \pm 5\%$)

Symbol	Characteristic	Condition	0°C		25°C		85°C		Unit
			Min	Max	Min	Max	Min	Max	
I_{INH} I_{INL}	Input HIGH Current Input LOW Current		0.5	255	0.5	175	0.5	175	μA
V_{IH1} V_{IL1}	Input HIGH Voltage Input LOW Voltage	$V_E = 5.0\text{ V}$	3.83 3.05	4.16 3.52	3.87 3.05	4.19 3.52	3.94 3.05	4.28 3.555	V
V_{BB1}	Output Reference Voltage		3.62	3.73	3.65	3.75	3.69	3.81	V

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

1. PECL levels are referenced to V_{CC} and will vary 1:1 with the power supply. The values shown are for $V_{CC} = 5.0\text{V}$.

Table 4. 100H PECL DC CHARACTERISTICS ($V_T = V_E = 5.0\text{ V} \pm 5\%$)

Symbol	Characteristic	Condition	0°C		25°C		85°C		Unit
			Min	Max	Min	Max	Min	Max	
I_{INH} I_{INL}	Input HIGH Current Input LOW Current		0.5	255	0.5	175	0.5	175	μA
V_{IH2} V_{IL2}	Input HIGH Voltage Input LOW Voltage	$V_E = 5.0\text{ V}$	3.835 3.19	4.12 3.525	3.835 3.19	4.12 3.525	3.835 3.19	4.12 3.525	V
V_{BB2}	Output Reference Voltage		3.62	3.74	3.62	3.74	3.62	3.74	V

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

2. PECL levels are referenced to V_{CC} and will vary 1:1 with the power supply. The values shown are for $V_{CC} = 5.0\text{V}$.

Table 5. TTL DC CHARACTERISTICS ($V_T = V_E = 5.0\text{ V} \pm 5\%$)

Symbol	Characteristic	Condition	0°C		25°C		85°C		Unit
			Min	Max	Min	Max	Min	Max	
V_{IH} V_{IL}	Input HIGH Voltage Input LOW Voltage		2.0	0.8	2.0	0.8	2.0	0.8	V
I_{IH}	Input HIGH Current	$V_{IN} = 2.7\text{ V}$ $V_{IN} = 7.0\text{ V}$		20 100		20 100		20 100	μA
I_{IL}	Input LOW Current	$V_{IN} = 0.5\text{ V}$		-0.6		-0.6		-0.6	mA
V_{OH}	Output HIGH Voltage	$I_{OH} = -3.0\text{ mA}$ $I_{OH} = -15\text{ mA}$	2.5 2.0		2.5 2.0		2.5 2.0		V
V_{OL}	Output LOW Voltage	$I_{OL} = 24\text{ mA}$		0.5		0.5		0.5	V
V_{IK}	Input Clamp Voltage	$I_{IN} = -18\text{ mA}$		-1.2		-1.2		-1.2	V
I_{OS}	Output Short Circuit Current	$V_{OUT} = 0\text{ V}$	-100	-225	-100	-225	-100	-225	mA

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

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Table 6. AC CHARACTERISTICS ($V_T = V_E = 5.0\text{ V} \pm 5\%$)

Symbol	Characteristic		Condition	0°C		25°C		85°C		Unit
				Min	Max	Min	Max	Min	Max	
t_{PLH}	Propagation Delay ECL D to Output	Q0 – Q3	CL = 25 pF	4.0	6.0	4.0	6.0	4.2	6.2	ns
t_{PLH}	Propagation Delay TTL D to Output		CL = 25 pF	4.0	6.0	4.0	6.0	4.3	6.3	ns
tskwd*	Within-Device Skew		CL = 25 pF		0.5		0.5		0.5	ns
t_{PLH}	Propagation Delay ECL D to Output	$\overline{Q0}, \overline{Q1}$	CL = 25 pF	4.0	6.0	4.0	6.0	4.2	6.2	ns
t_{PLH}	Propagation Delay TTL D to Output		CL = 25 pF	4.0	6.0	4.0	6.0	4.3	6.3	ns
t_{PLH}	Propagation Delay ECL D to Output	Q4, Q5	CL = 25 pF	4.0	6.0	4.0	6.0	4.2	6.2	ns
t_{PLH}	Propagation Delay TTL D to Output		CL = 25 pF	4.0	6.0	4.0	6.0	4.3	6.3	ns
t_{PD}	Propagation Delay R to Output	All Outputs	CL = 25 pF	4.3	6.3	4.3	6.3	5.0	7.0	ns
t_R t_F	Output Rise/Fall Time 0.8 V to 2.0 V	All Outputs	CL = 25 pF		2.5 2.5		2.5 2.5		2.5 2.5	ns
f_{max}	Maximum Input Frequency		CL = 25 pF	135		135		135		MHz
t_{pw}	Minimum Pulse Width			1.50		1.50		1.50		ns
t_{rr}	Reset Recovery Time			1.25		1.25		1.25		ns

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

3. Within-Device Skew defined as identical transitions on similar paths through a device.

Table 7. V_{CC} and C_L RANGES TO MEET DUTY CYCLE REQUIREMENTS

(0°C ≤ T_A ≤ 85°C Output Duty Cycle Measured Relative to 1.5 V)

Symbol	Characteristic		Condition	Min	Nom	Max	Unit
	Range of V_{CC} and C_L to meet minimum pulse width (HIGH or LOW) = 11.5 ns at $f_{out} \leq 40$ MHz	V_{CC} C_L	$\overline{Q0} - \overline{Q3}$ $\overline{Q0} - \overline{Q1}$	4.75 10	5.0	5.25 50	V pF
	Range of V_{CC} and C_L to meet minimum pulse width (HIGH or LOW) = 9.5 ns at $40 < f_{out} \leq 50$ MHz	V_{CC} C_L	Q0 – Q3	4.875 15	5.0	5.125 27	V pF

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10/100H640 DUTY CYCLE CONTROL

To maintain a duty cycle of $\pm 5\%$ at 50MHz, limit the load capacitance and/or power supply variation as shown in Figures 3 and 4. For a $\pm 2.5\%$ duty cycle limit, see Figures 5 and 6. Figures 7 and 8 show duty cycle variation with temperature. Figure 9 shows typical TPD versus load. Figure 10 shows reset recovery time. Figure 11 shows output states after power up.

Best duty cycle control is obtained with a single μP load and minimum line length.

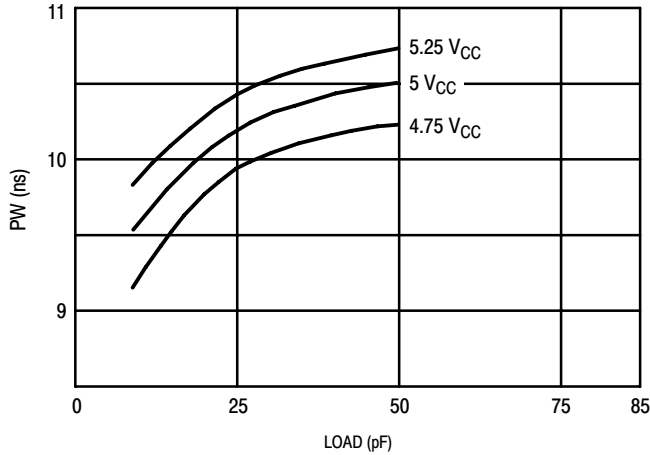


Figure 3. Positive Pulse Width at 25°C Ambient and 50 MHz Out

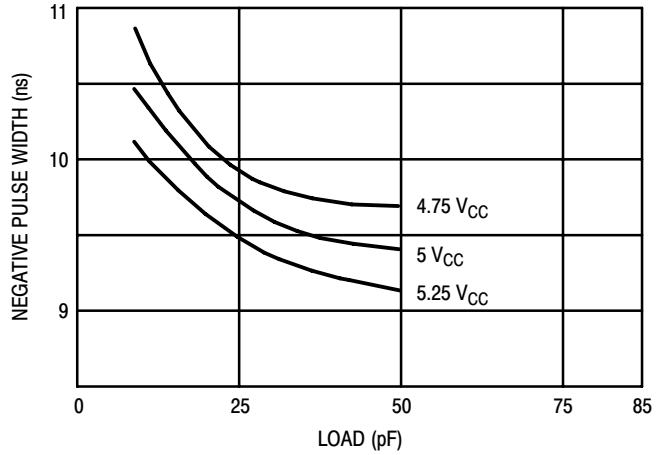


Figure 4. Negative Pulse Width at 25°C Ambient and 50 MHz Out

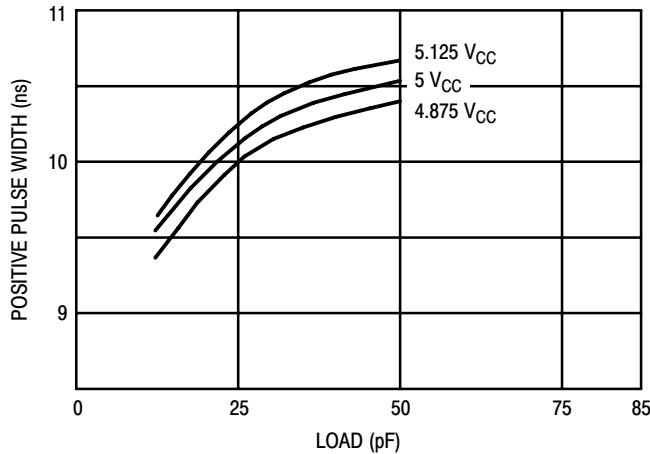


Figure 5. Positive Pulse Width at 25°C Ambient at 50 MHz Out

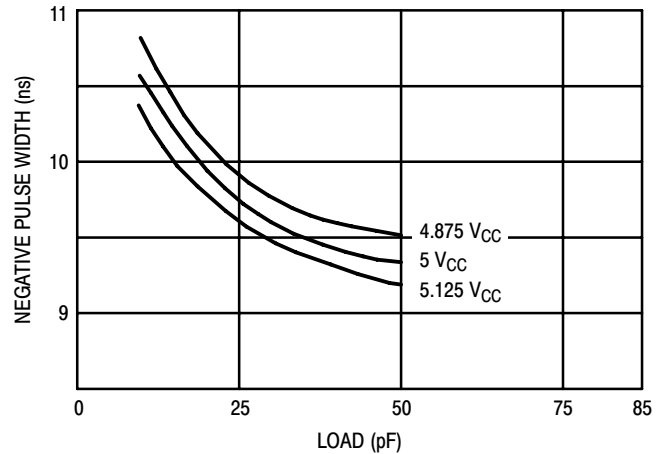


Figure 6. Negative Pulse Width at 25°C Ambient at 50 MHz Out

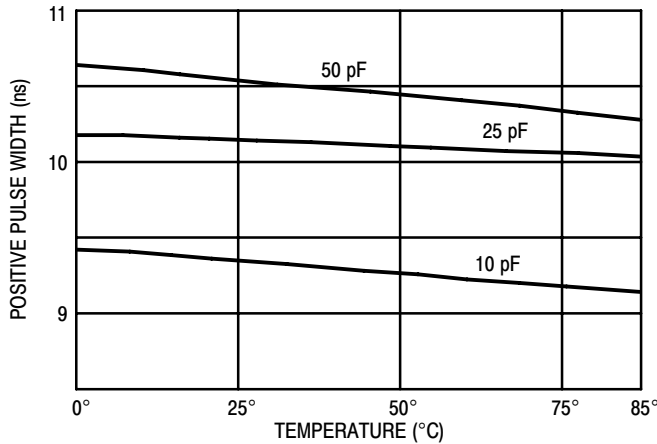


Figure 7. Temperature versus Positive Pulse Width for 100H640 at 50 MHz and $V_{CC} = +5.0\text{ V}$

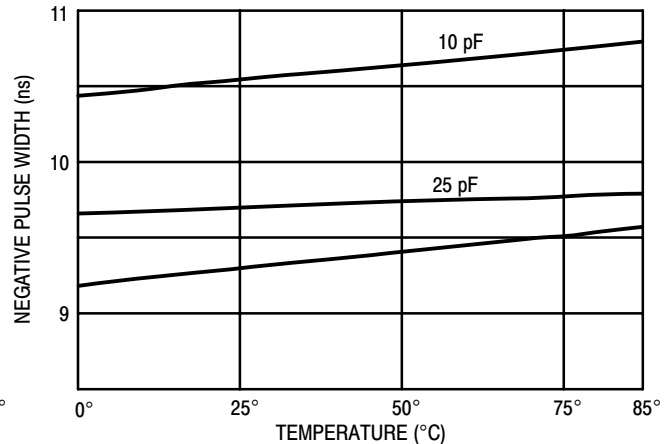


Figure 8. Temperature versus Negative Pulse Width for MC100H640 @ 50 MHz and $V_{CC} = +5.0\text{ V}$

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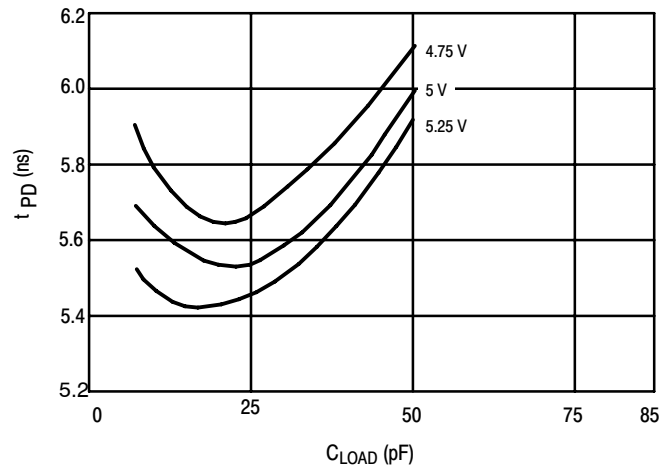


Figure 9. t_{PD} versus Load Typical at $T_A = 25^\circ\text{C}$

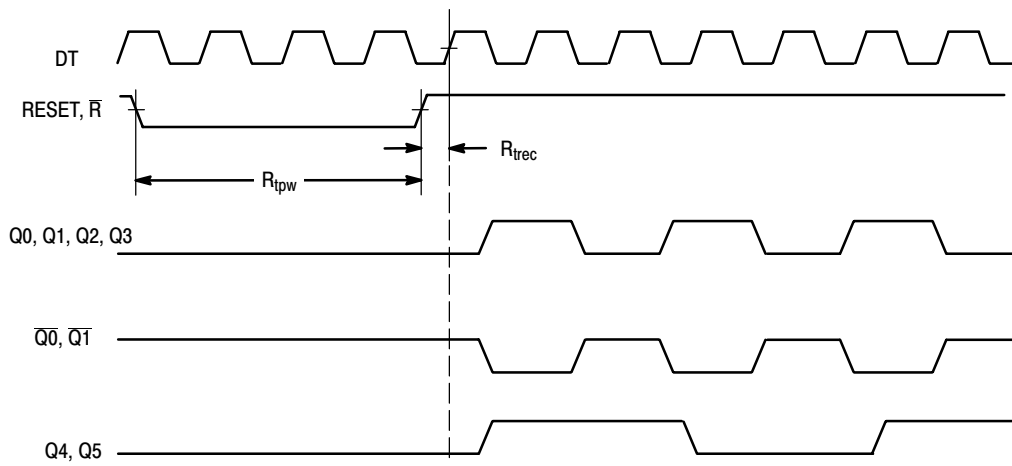
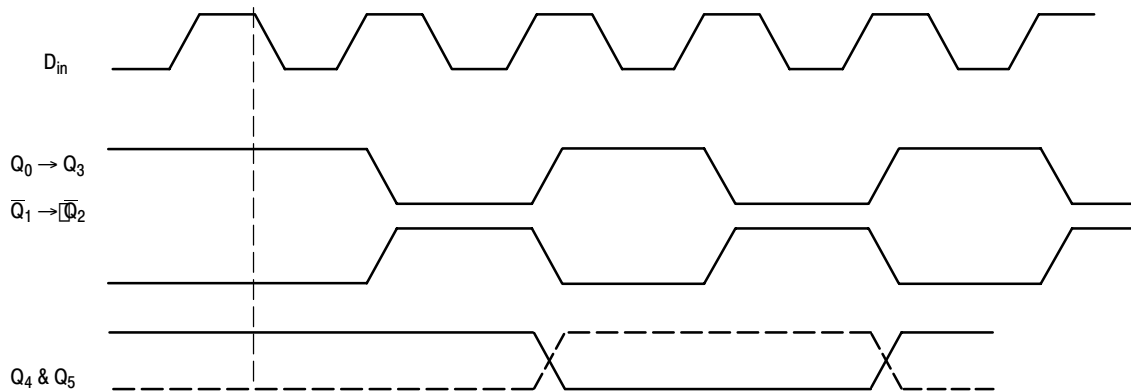


Figure 10. MC10H/100H640 Clock Phase and Reset Recovery Time After Reset Pulse



AFTER POWER UP
 OUTPUTS Q_4 & Q_5 WILL SYNC WITH POSITIVE EDGES OF D_{in} & $Q_0 \rightarrow Q_3$ & NEGATIVE EDGES OF \bar{Q}_0 & \bar{Q}_1

Figure 11. Output Timing Diagram

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ORDERING INFORMATION

Device	Package	Shipping†
MC10H640FN	PLCC-28	37 Units / Rail
MC10H640FNG	PLCC-28 (Pb-Free)	37 Units / Rail
MC10H640FNR2	PLCC-28	500 / Tape & Reel
MC10H640FNR2G	PLCC-28 (Pb-Free)	500 / Tape & Reel
MC100H640FN	PLCC-28	37 Units / Rail
MC100H640FNG	PLCC-28 (Pb-Free)	37 Units / Rail
MC100H640FNR2	PLCC-28	500 / Tape & Reel
MC100H640FNR2G	PLCC-28 (Pb-Free)	500 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

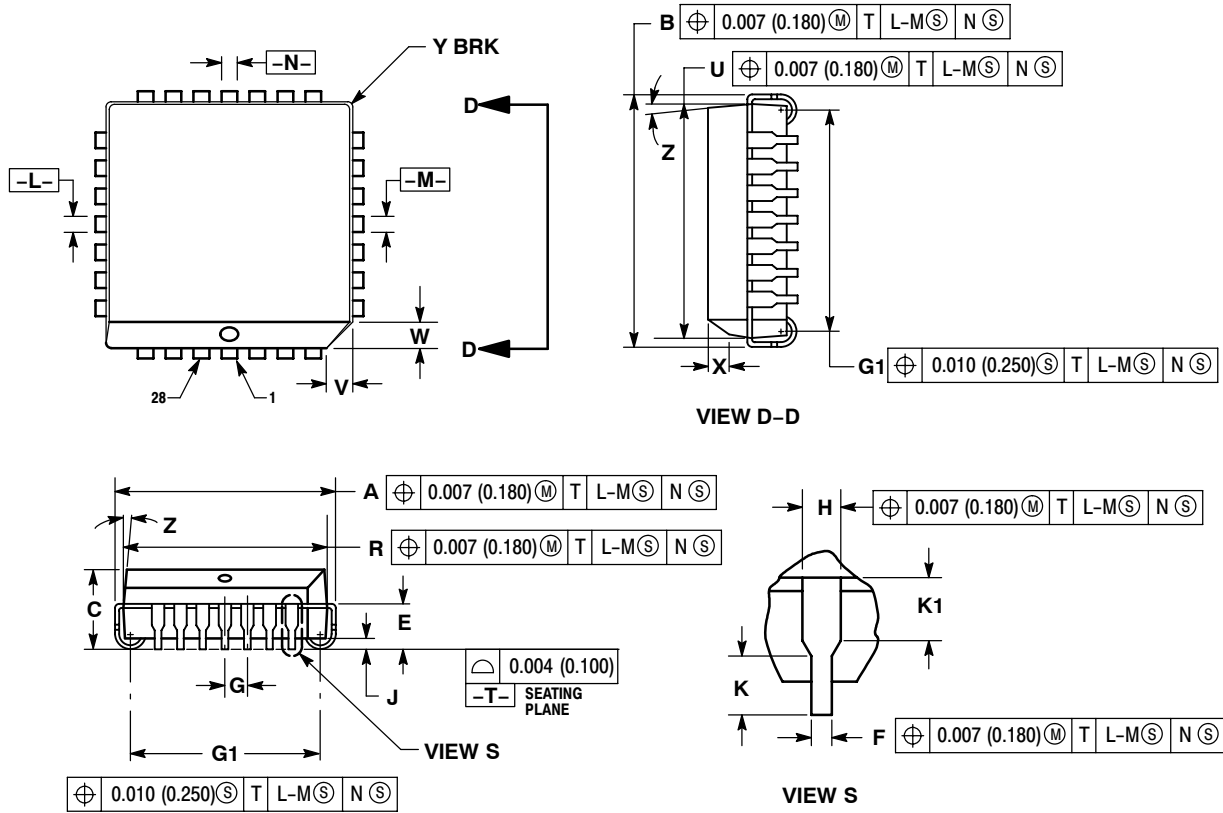
Resource Reference of Application Notes

- AN1405/D** – ECL Clock Distribution Techniques
- AN1406/D** – Designing with PECL (ECL at +5.0 V)
- AN1503/D** – ECLinPS™ I/O SPICE Modeling Kit
- AN1504/D** – Metastability and the ECLinPS Family
- AN1568/D** – Interfacing Between LVDS and ECL
- AN1672/D** – The ECL Translator Guide
- AND8001/D** – Odd Number Counters Design
- AND8002/D** – Marking and Date Codes
- AND8020/D** – Termination of ECL Logic Devices
- AND8066/D** – Interfacing with ECLinPS
- AND8090/D** – AC Characteristics of ECL Devices

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PACKAGE DIMENSIONS

PLCC-28
FN SUFFIX
PLASTIC PLCC PACKAGE
CASE 776-02
ISSUE E



NOTES:

- DATUMS -L-, -M-, AND -N- DETERMINED WHERE TOP OF LEAD SHOULDER EXITS PLASTIC BODY AT MOLD PARTING LINE.
- DIMENSION G1, TRUE POSITION TO BE MEASURED AT DATUM -T-, SEATING PLANE.
- DIMENSIONS R AND U DO NOT INCLUDE MOLD FLASH. ALLOWABLE MOLD FLASH IS 0.010 (0.250) PER SIDE.
- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: INCH.
- THE PACKAGE BOTTOM MAY BE SMALLER THAN THE PACKAGE TOP BY UP TO 0.012 (0.300). DIMENSIONS R AND U ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH, TIE BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.
- DIMENSION H DOES NOT INCLUDE DAMBAR PROTRUSION OR INTRUSION. THE DAMBAR PROTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE GREATER THAN 0.037 (0.940). THE DAMBAR INTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE SMALLER THAN 0.025 (0.635).

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.485	0.495	12.32	12.57
B	0.485	0.495	12.32	12.57
C	0.165	0.180	4.20	4.57
E	0.090	0.110	2.29	2.79
F	0.013	0.019	0.33	0.48
G	0.050 BSC		1.27 BSC	
H	0.026	0.032	0.66	0.81
J	0.020	---	0.51	---
K	0.025	---	0.64	---
R	0.450	0.456	11.43	11.58
U	0.450	0.456	11.43	11.58
V	0.042	0.048	1.07	1.21
W	0.042	0.048	1.07	1.21
X	0.042	0.056	1.07	1.42
Y	---	0.020	---	0.50
Z	2° 10°		2° 10°	
G1	0.410	0.430	10.42	10.92
K1	0.040	---	1.02	---

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- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



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